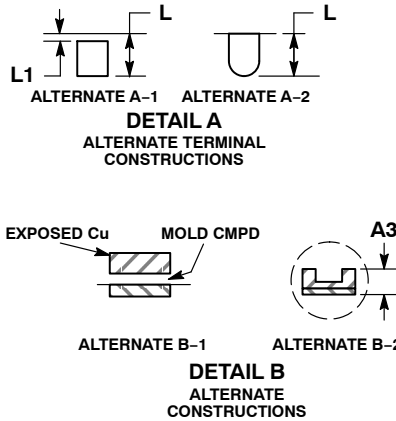
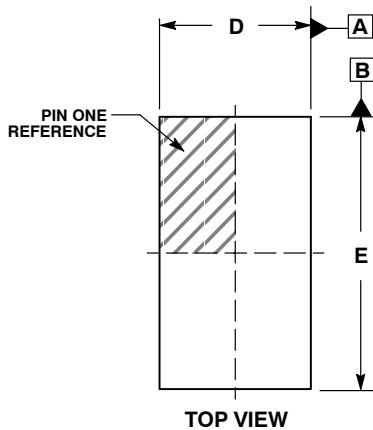


SCALE 2:1

QFN20 2.5x4.5, 0.5P
CASE 485FK
ISSUE O

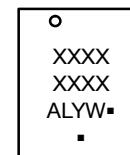
DATE 08 MAY 2017



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSIONS b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.20 AND 0.25MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

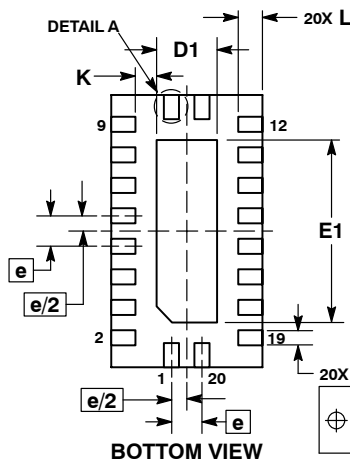
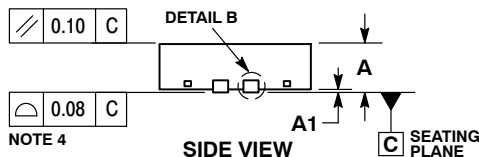
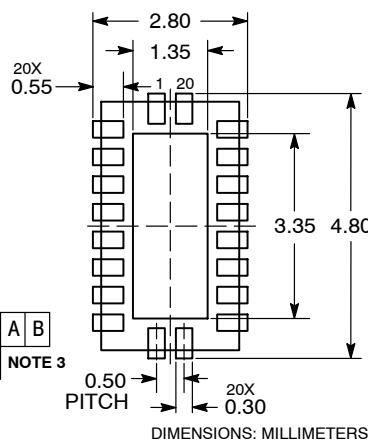
| MILLIMETERS | | | |
|-------------|-----------|------|------|
| DIM | MIN | NOM | MAX |
| A | 0.80 | 0.90 | 1.00 |
| A1 | --- | --- | 0.05 |
| A3 | 0.203 REF | | |
| b | 0.20 | 0.25 | 0.30 |
| D | 2.40 | 2.50 | 2.60 |
| D1 | 0.95 | 1.05 | 1.15 |
| E | 4.40 | 4.50 | 4.60 |
| E1 | 2.95 | 3.05 | 3.15 |
| e | 0.50 BSC | | |
| K | 0.325 REF | | |
| L | 0.30 | 0.40 | 0.50 |
| L1 | --- | --- | 0.05 |

GENERIC MARKING
DIAGRAM*


- XXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.


RECOMMENDED
SOLDERING FOOTPRINT


DIMENSIONS: MILLIMETERS

| | | |
|-------------------------|----------------------------|--|
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| DESCRIPTION: | QFN20 2.5X4.5, 0.5P | PAGE 1 OF 1 |

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